

## Description

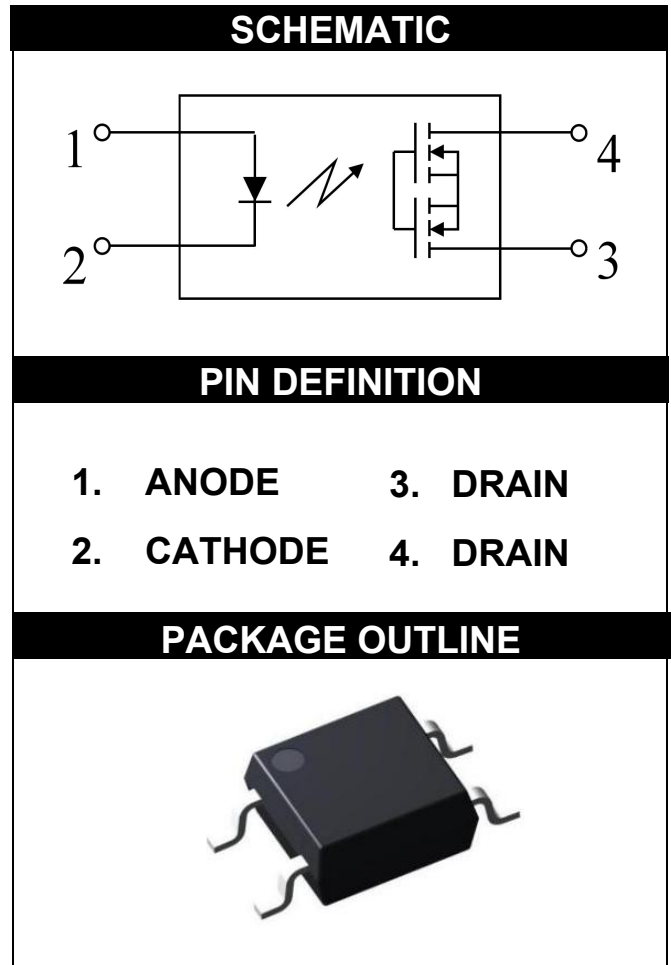
The JOR217 Photo relay consist of a photo MOSFET、Photovoltage generator、infrared LED.

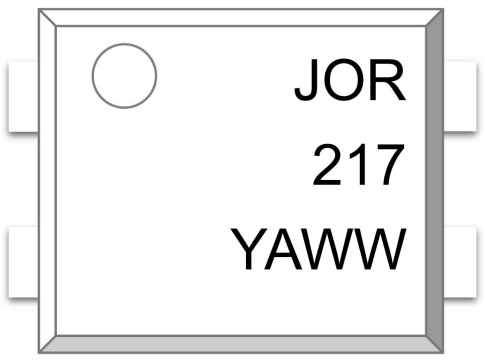

## Features

- Normally opened (SPST)
- Control 200V AC or DC voltage
- Switch 180mA load
- Controls low-level analog signal
- High sensitivity, low conductivity resistance
- Low-level off state leakage current
- High isolation voltage 3750V<sub>rms</sub>
- Lead free, meet RoHS standards

## Applications

- Communications products (Personal computers, Laptops)
- Modem/Sensor
- Mobile phones/Security equipment
- Measuring and Testing equipment
- Plant automation equipment
- High-speed inspection machines



ORDERING AND MARKING INFORMATION	
MARKING INFORMATION	
	<p>JOR : Company Abbr. 217 : Part Number YAWW : LOT NO.</p>
ORDERING INFORMATION	LABEL INFORMATION
<p style="text-align: center;"><b>JOR217(Z)-GV</b></p> <p>JOC– Company Abbr 217 – Part Number Z – Tape and Reel Option (T1/T2) G – Green V – VDE</p>	

## Insulation and Safety related specifications

Item	Symbol	Value	Unit	Note
Creepage Distance	L	5.0	mm	Measured from input terminals to output terminals, shortest distance path along body.
Clearance Distance	L	5.0	mm	Measured from input terminals to output terminals, shortest distance through air.
Insulation Thickness	DTI	0.3	mm	Insulation thickness between emitter and detector.
Peak Isolation Voltage	$V_{IORM}$	600	$V_{peak}$	DIN/EN/IEC EN60747-5-5.
Transient Isolation Voltage	$V_{IOTM}$	5000	$V_{peak}$	DIN/EN/IEC EN60747-5-5.
Isolation Voltage	$V_{ISO}$	3750	$V_{rms}$	For 1 minute.

## Absolute Maximum Ratings ( $T_A=25^{\circ}C$ )

Parameter		Symbol	Rating	Unit
Input	LED Forward Current	$I_F$	50	mA
	LED Reverse Voltage	$V_R$	5	V
	Peak Forward Current	$I_{FP}$	1	A
	Power Dissipation	$P_{in}$	75	mW
Output	Load Voltage (Peak AC)	$V_L$	200	V
	Continuous Load Current	$I_L$	0.18	A
	Peak Load Current	$I_{peak}$	0.54	A
	Power Dissipation	$P_{out}$	300	mW
Isolation Voltage		$V_{ISO}$	3750	$V_{rms}$
Operating Temperature		$T_{opr}$	-40~+85	$^{\circ}C$
Storage Temperature		$T_{stg}$	-40~+100	$^{\circ}C$
Soldering Temperature		$T_{sol}$	260	$^{\circ}C$

## Electro-optical Characteristics (T<sub>A</sub>=25°C)

Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit
Input	LED Operate Current	I <sub>Fon</sub>	I <sub>L</sub> = 0.18A	-	0.6	3	mA
	LED Turn Off Current	I <sub>Foff</sub>	I <sub>L</sub> = 0.18A	0.05	0.5	-	mA
	LED Dropout Voltage	V <sub>F</sub>	I <sub>F</sub> =5mA	1	1.3	1.4	V
Output	On Resistance	R <sub>on</sub>	I <sub>F</sub> = 5mA , I <sub>L</sub> = 0.18A Within 1s on time	-	2.2	5	Ω
	Off State Leakage Current	I <sub>Leak</sub>	I <sub>F</sub> = 0mA V <sub>L</sub> = 200V	-	-	1000	nA
Transfer Characteristics	Turn On Time	T <sub>on</sub>	I <sub>F</sub> = 5mA I <sub>L</sub> = 0.18A R <sub>L</sub> =200Ω	-	0.16	2	ms
	Turn Off Time	T <sub>off</sub>	I <sub>F</sub> = 5mA I <sub>L</sub> = 0.18A R <sub>L</sub> =200Ω	-	0.14	1	ms
	I/O Capacitance	C <sub>ISO</sub>	f = 1 MHz V <sub>B</sub> =0V	-	0.8	1.5	pF
	Initial I/O Isolation Resistance	R <sub>ISO</sub>	500 V DC	1000	-	-	MΩ

## Typical Electro-Optical Characteristics Curves

Fig.1 LED Dropout Voltage vs. Ambient Temperature

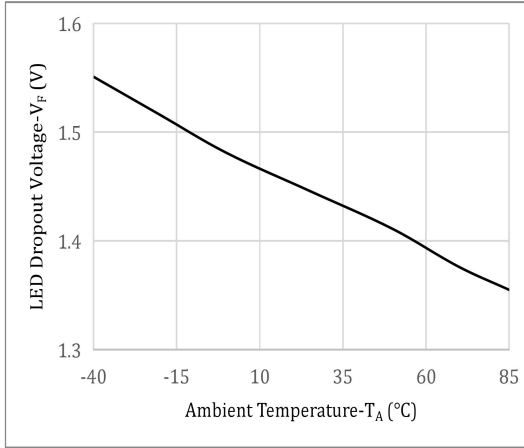


Fig.2 Output Current vs. Output Voltage

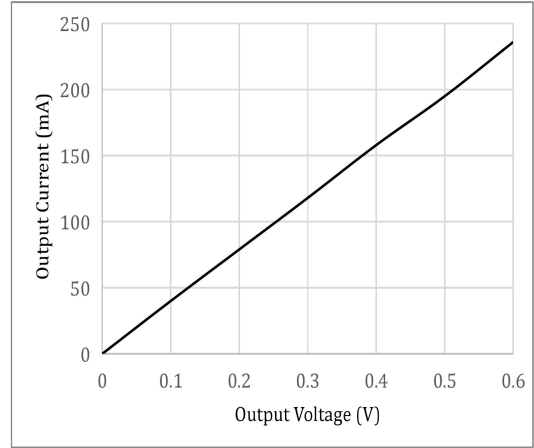


Fig.3 On Resistance vs. Ambient Temperature

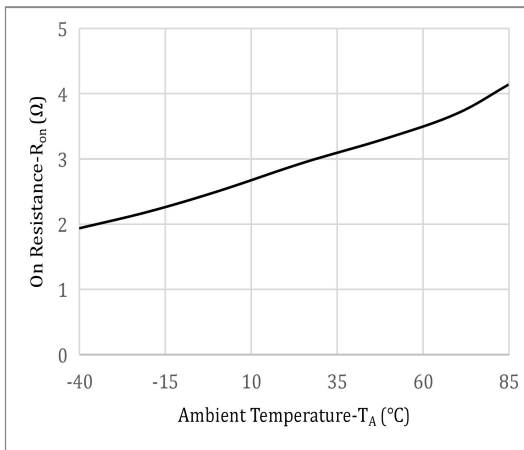


Fig.4 Load Current vs. Ambient Temperature

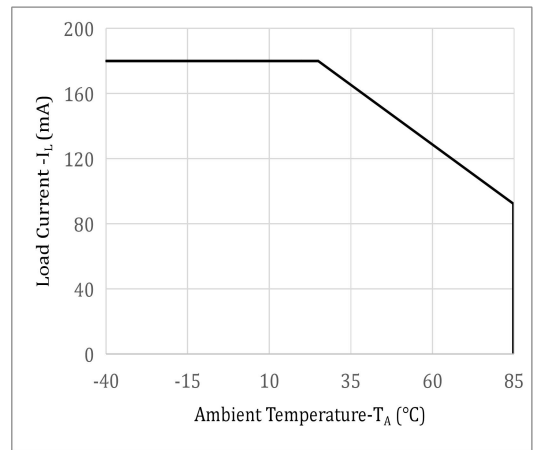


Fig.5 LED Operate Current vs. Ambient Temperature

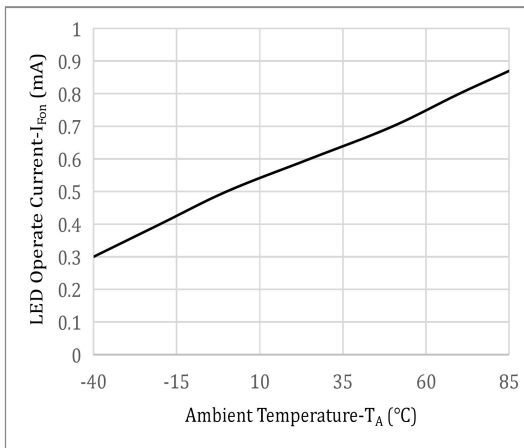


Fig.6 LED Turn Off Current vs. Ambient Temperature

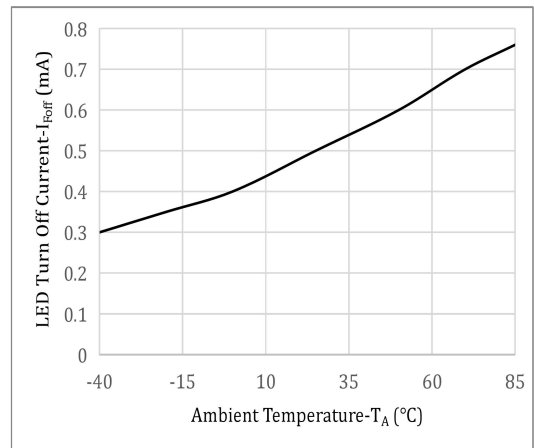


Fig.7 Turn On Time vs. Ambient Temperature

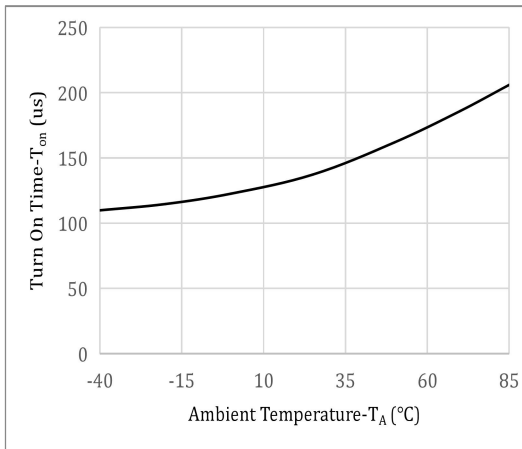


Fig.8 Turn Off Time vs. Ambient Temperature

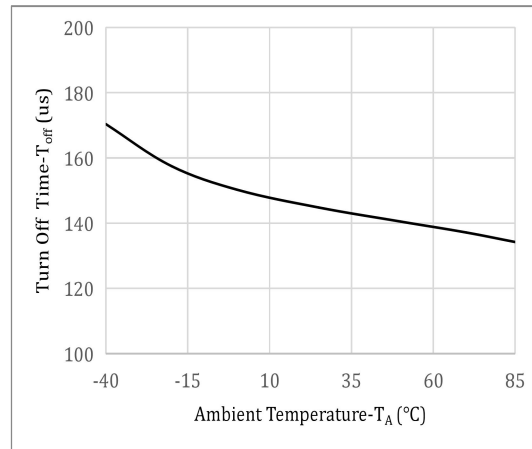


Fig.9 Turn On Time vs. LED Forward Current

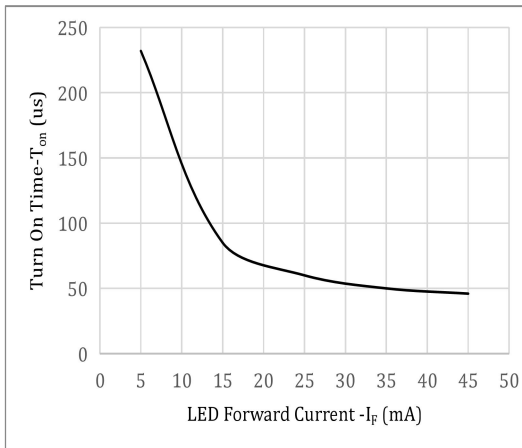
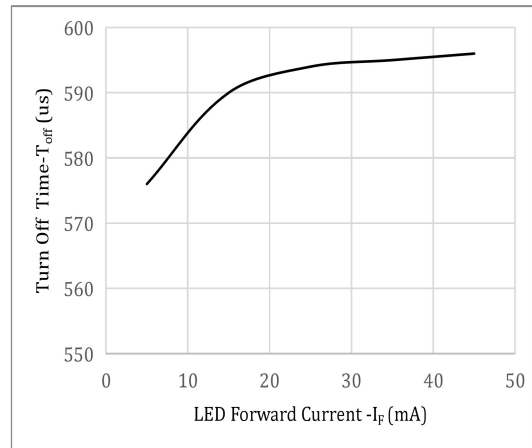
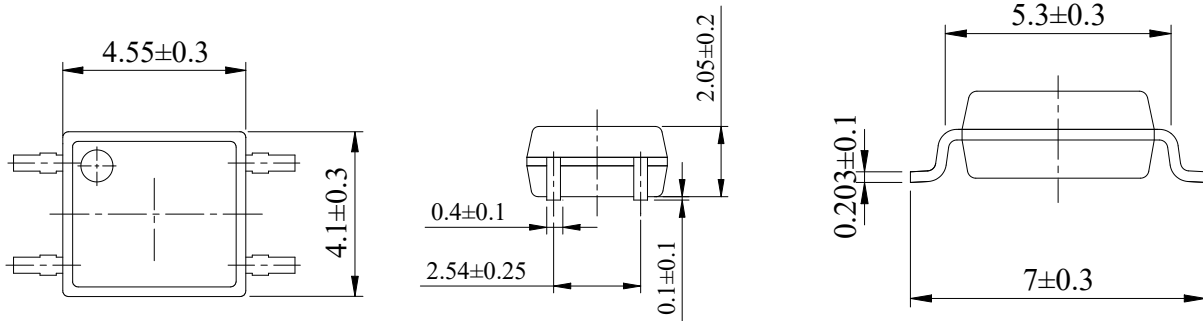


Fig.10 Turn Off Time vs. LED Forward Current



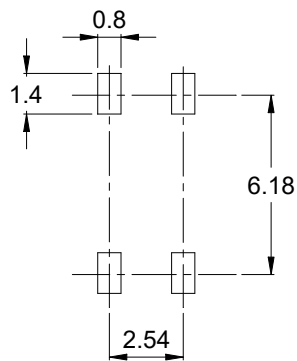
### Outline Dimensions

SOP4



Unit: mm

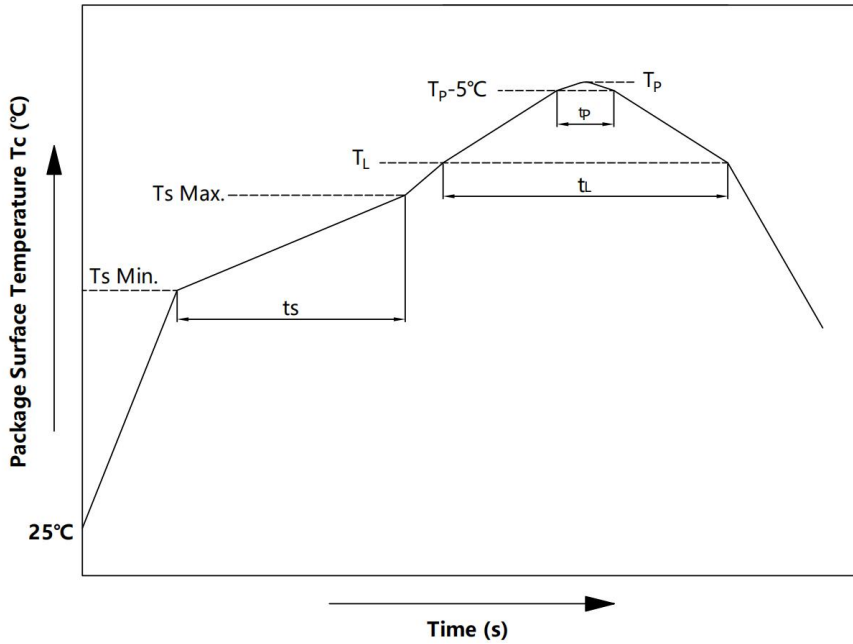
### Recommended Pad Layout



Unit: mm

**Note > The picture above is the front view of the product.**

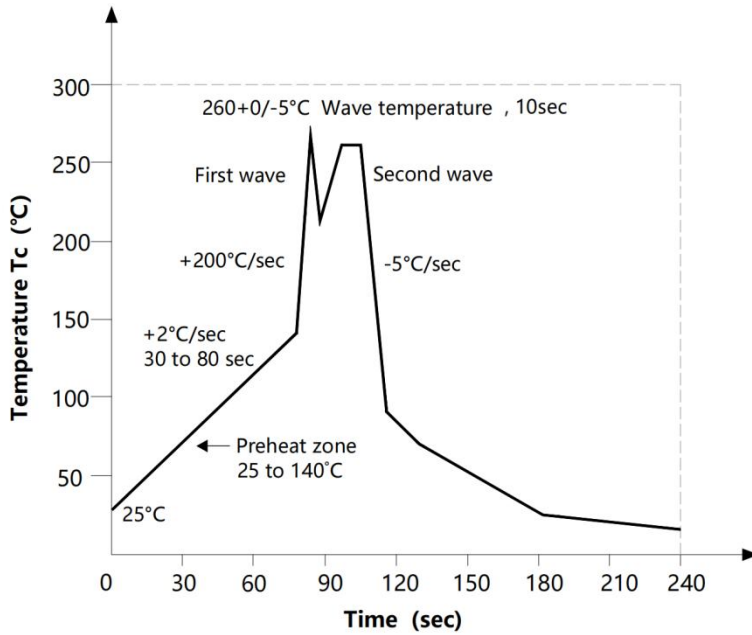
**Solder Reflow Profile**



Item	Symbol	Min.	Max.	Unit
Preheat Temperature	$T_s$	150	200	$^\circ\text{C}$
Preheat Time	$t_s$	60	120	s
Ramp-Up Rate ( $T_l$ to $T_p$ )	-	-	3	$^\circ\text{C}/\text{s}$
Liquidus Temperature	$T_l$	217		$^\circ\text{C}$
Time Above $T_l$	$t_l$	60	150	s
Peak Temperature	$T_p$	-	260	$^\circ\text{C}$
Time During Which $T_c$ Is Between ( $T_p-5$ ) and $T_p$	$t_p$	-	30	s
Ramp-down Rate( $T_p$ to $T_l$ )	-	-	6	$^\circ\text{C}/\text{s}$

Note: Reflow soldering is recommended at the temperatures and times shown, no more than three times.

### Wave Soldering Profile



### Soldering with hand soldering iron

- A. Hand soldering iron is only used for product rework or sample testing;
- B. Manual soldering method Temperature: 360°C ± 5°C, within 3s.

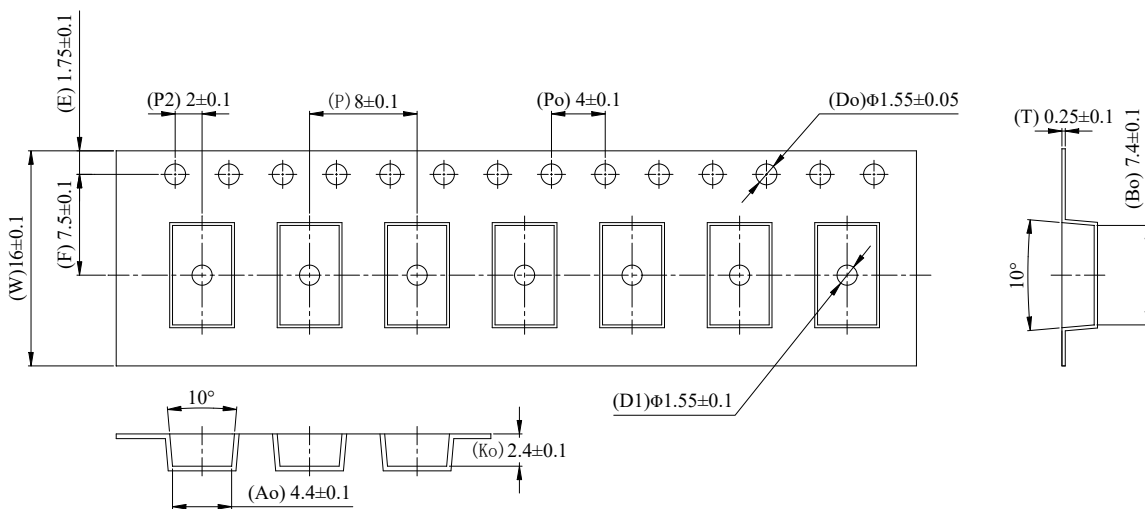
## Packing

### Summary table

Package Type	Packing Form	Quantity per Reel	Quantity per Box	Quantity per Carton	Antistatic Bag Specification	Box Specification	Carton Specification	Note
SOP4	Reel (φ330mm Blue)	3000 pcs /reel	2 reels /box	10 boxes /ctn	380*380mm	340*60*340 mm	620*360*365cm	Leave at least 200mm of blank space at both ends

### Tape & Reel

- 1) Qty/reel: 3000 pcs.
- 2) Qty/ctn: 60000 pcs.
- 3) Inner packing: 2 reels/box.
- 4) Schematic:



Unit: mm